Amendments to the Claims:

This listing of claims will replace all prior versions and listing of claims in the application.

Claims 12-17 and 19-22 are amended.

Listing of Claims:

1-10 (Canceled)

11. (Original) A method for producing an optical disk including a first substrate having a central hole A and a second substrate that is transparent and has a central hole B whose diameter is larger than that of the central hole A, comprising the processes of:

(a) bringing the first substrate having a signal area on a principal plane and the second substrate that is thinner than the first substrate into contact with each other with radiation curable resin interposed therebetween so that the principal plane faces inside; and

(b) irradiating the radiation curable resin with radiation to cure the radiation curable resin, thereby attaching the first substrate to the second substrate,

wherein, in the process (a), the radiation curable resin is disposed so as to extend at least from an inner peripheral edge of the second substrate to an outer peripheral edge thereof.

12. (Currently Amended) [[A]] The method for producing an optical disk according to claim 11, wherein a thickness of the second substrate is in a range of 0.03 mm to 0.3 mm.

13. (Currently Amended) [[A]] The method for producing an optical disk according to claim 11, wherein the process (a) includes interposing the radiation curable resin between the first and second substrates, and rotating the first and second substrates to draw the radiation curable resin.

14. (Currently Amended) [[A]] The method for producing an optical disk according to claim 11, wherein the process (a) includes pouring the radiation curable resin onto the first substrate, rotating the first substrate to coat the first substrate with the radiation curable resin, and bringing the first substrate and the second substrate into contact with each other with the radiation curable resin interposed therebetween.

15. (Currently Amended) [[A]] The method for producing an optical disk according to claim 14, wherein, in the process (a), the first substrate and the second substrate are brought into contact with each other in a vacuum atmosphere.

16. (Currently Amended) [[A]] The method for producing an optical disk according to claim 11, wherein the first substrate includes, on the principal plane, at least one selected from the group consisting of a convex portion formed in a circular shape so as to surround the central hole A and having an outer diameter equal to or smaller than a diameter of the central hole B, and a concave portion formed in a circular shape so as to surround the central hole A and having a diameter equal to or smaller than that of the central hole B.

17. (Currently Amended) [[A]] The method for producing an optical disk according to claim 16, wherein a height of the convex portion is larger than a sum of a thickness of the second substrate and a thickness of the radiation curable resin.

18. (Original) A method for producing an optical disk, comprising the processes of:

(A) bringing a first substrate having a signal area on a principal plane and a central hole A and a second substrate that is transparent and thinner than the first substrate into contact with each other with radiation curable resin interposed therebetween so that the principal plane faces inside;

(B) irradiating the radiation curable resin with radiation to cure the radiation curable resin, thereby attaching the first substrate to the second substrate; and

(C) removing a part of the second substrate to form a central hole B whose diameter is larger than that of the central hole A in the second substrate,

wherein, in the process (A), the radiation curable resin is disposed so as to extend at least from an outer periphery of a position where the central hole B is formed to an outer peripheral edge of the second substrate.

19. (Currently Amended) [[A]] The method for producing an optical disk according to claim 18, wherein a thickness of the second substrate is in a range of 0.03 mm to 0.3 mm.

20. (Currently Amended) [[A]] The method for producing an optical disk according to claim 18, wherein the process (A) includes interposing the radiation curable resin

between the first and second substrates, and rotating the first and second substrates to draw the radiation curable resin.

21. (Currently Amended) [[A]] The method for producing an optical disk according to claim 18, wherein the process (A) includes pouring the radiation curable resin onto the first substrate, rotating the first substrate to coat the first substrate with the radiation curable resin, and bringing the first substrate and the second substrate into contact with each other with the radiation curable resin interposed therebetween.

22. (Currently Amended) [[A]] The method for producing an optical disk according to claim 21, wherein, in the process (A), the first substrate and the second substrate are brought into contact with each other in a vacuum atmosphere.

23-40 (Canceled)